

GENERAL DESCRIPTION

The 1117 is a series of low dropout three-terminal regulators with a dropout of 1.15V at 1A output current.

The 1117 series provides current limiting and thermal shutdown. Its circuit includes a trimmed bandgap reference to assure output voltage accuracy to be within 1%. Current limit is trimmed to ensure specified output Current and controlled short-circuit current. On-chip thermal shutdown provides protection against any combination of overload and ambient temperature that would create excessive junction temperature.

The 1117 has an adjustable version, that can provide the output voltage from 1.25V to 5V with only 2 external resistors.

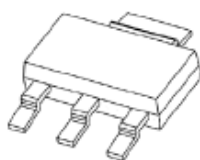
The 1117 series is available in the industry standard SOT-223,SOT-89,TO-220,TO-252 and TO-263 power packages.

FEATURES

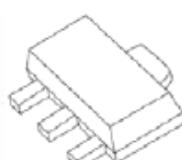
- Low Dropout Voltage: 1.15V at 1A Output Current
- Trimmed Current Limit
- On-Chip Thermal Shutdown
- Three-Terminal Adjustable or Fixed 1.5V, 1.8V, 2.5V, 3.3V, 5V
- Operation junction Temperature: 0 °C to125°C

APPLICATIONS

- PC Motherboard
- LCD Monitor
- Graphic Card
- DVD-Video player
- NIC/Switch
- Telecom Modem
- ADSL Modem
- Printer and other peripheral Equipment



SOT-223



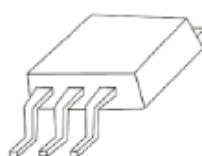
SOT-89-3L



TO-220



TO-252



TO-263

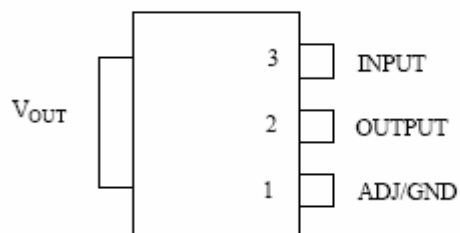


TO-251

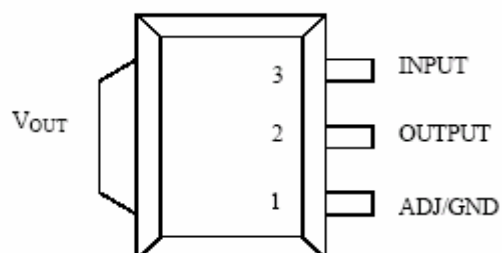
Figure 1. Package Types of 1117

PIN CONFIGURATIONS

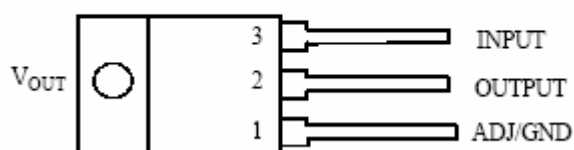
T Package
(SOT-223)



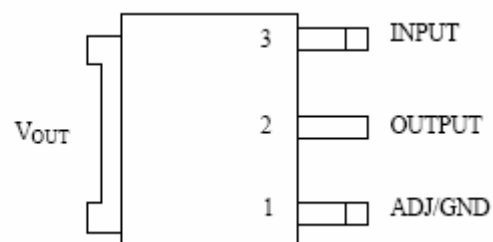
A Package
(SOT-89)



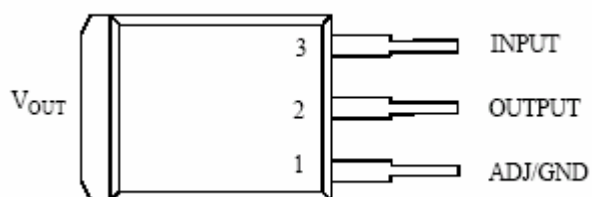
P Package
(TO-220)



U Package
(TO-252)



B Package
(TO-263)



D Package
(TO-251)

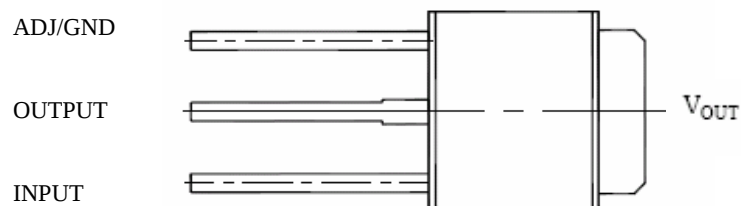


Figure 2. Pin Configurations of 1117

1A LOW DROPOUT LINEAR REGULATOR

FUNCTIONAL BLOCK DIAGRAM

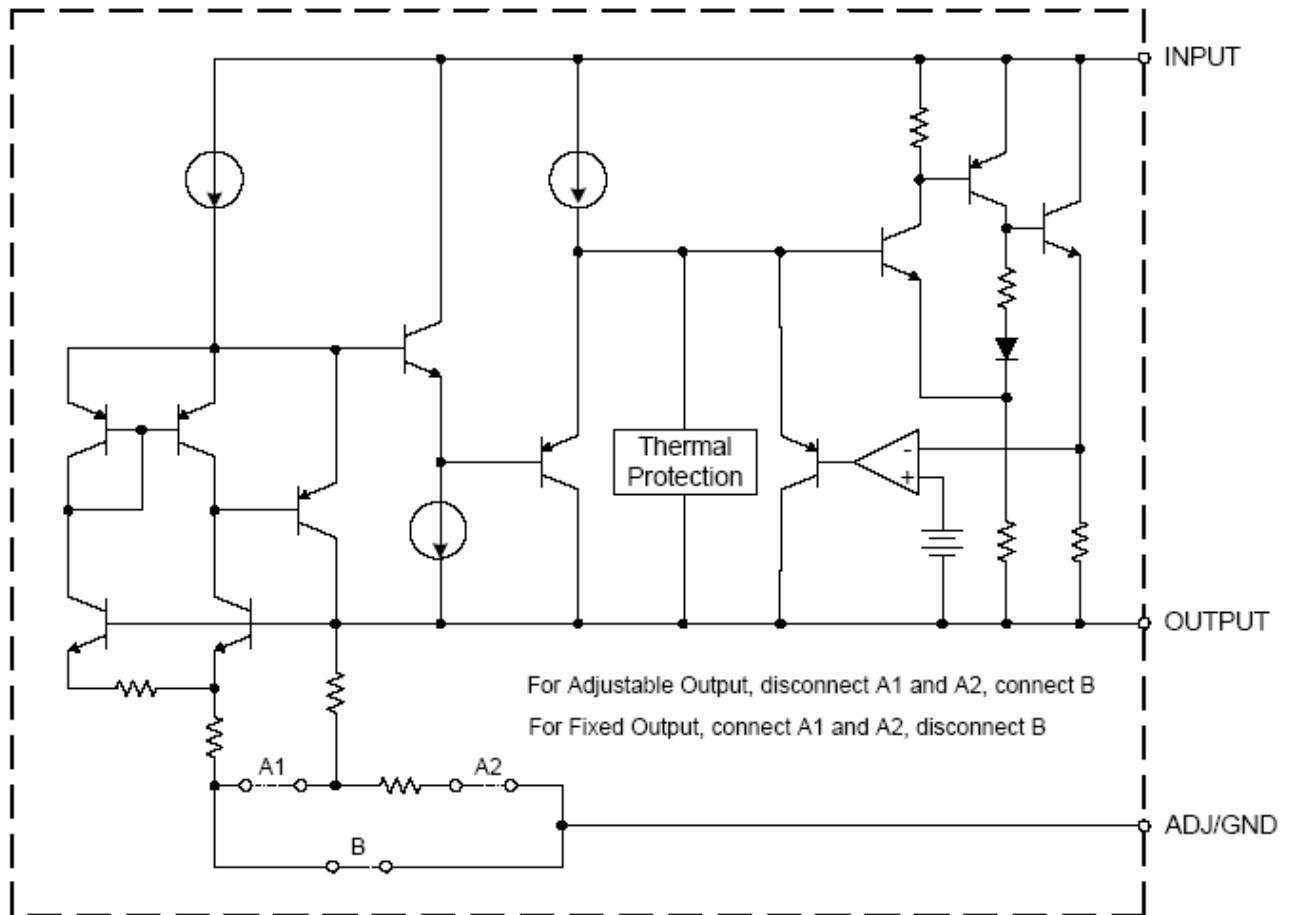


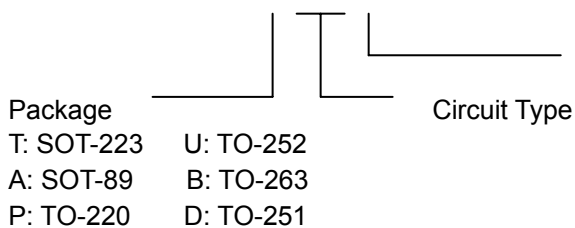
Figure 3. Functional Block Diagram of 1117

1A LOW DROPOUT LINEAR REGULATOR

ORDERING INFORMATION

Package	Operating Junction Temperature Range	Part Number
SOT-223	0 to 125°C	T1117-ADJ
		T1117-1.5
		T1117-1.8
		T1117-2.5
		T1117-3.3
		T1117-5.0
SOT-89	0 to 125°C	A1117-ADJ
		A1117-1.5
		A1117-1.8
		A1117-2.5
		A1117-3.3
		A1117-5.0
TO-220	0 to 125°C	P1117-ADJ
		P1117-1.5
		P1117-1.8
		P1117-2.5
		P1117-3.3
		P1117-5.0
TO-252	0 to 125°C	U1117-ADJ
		U1117-1.5
		U1117-1.8
		U1117-2.5
		U1117-3.3
		U1117-5.0
TO-263	0 to 125°C	B1117-ADJ
		B1117-1.5
		B1117-1.8
		B1117-2.5
		B1117-3.3
		B1117-5.0
TO-251	0 to 125°C	D1117-ADJ
		D1117-1.5
		D1117-1.8
		D1117-2.5
		D1117-3.3
		D1117-5.0

X 1117- Z



ADJ: Adjustable Output

1.5: Fixed Output 1.5V

1.8: Fixed Output 1.8V

2.5: Fixed Output 2.5V

3.3: Fixed Output 3.3V

5.0: Fixed Output 5.0V

ABOSLUTE MAXIMUM RATINGS (NOTE 1)

Parameter	Value	Unit
V _{IN}	20	V
Maximum Junction Temperature	150	°C
Storage Temperature Range	-65 to 150	°C
Lead Temperature (Soldering, 10sec.)	300	°C
ESD (Machine Model)	600	V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Parameter	Min	Max	Unit
V _{IN}		15	V
Operating Junction Temperature Range	0	125	°C

Operating Conditions: $V_{IN} \leq 10V$, $T_J = 25^\circ C$ unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Unit
Reference Voltage	1117-ADJ, $I_{OUT} = 10mA$, $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$, $1.4V \leq V_{IN} - V_{OUT} \leq 8V$, $P \leq$ Maximum power Dissipation	1.238 1.225	1.250 1.250	1.262 1.270	V
Output Voltage	1117-1.5, $I_{OUT} = 10mA$, $V_{IN} = 3.5V$ $10mA \leq I_{OUT} \leq 1A$, $3.0V \leq V_{IN} \leq 10V$	1.485 1.470	1.5 1.5	1.515 1.530	V
	1117-1.8, $I_{OUT} = 10mA$, $V_{IN} = 3.8V$ $10mA \leq I_{OUT} \leq 1A$, $3.2V \leq V_{IN} \leq 10V$	1.782 1.746	1.8 1.8	1.818 1.854	V
	1117-2.5, $I_{OUT} = 10mA$, $V_{IN} = 4.5V$ $10mA \leq I_{OUT} \leq 1A$, $3.9V \leq V_{IN} \leq 10V$	2.475 2.450	2.5 2.5	2.525 2.550	V
	1117-3.3, $I_{OUT} = 10mA$, $V_{IN} = 5.0V$ $10mA \leq I_{OUT} \leq 1A$, $4.75V \leq V_{IN} \leq 10V$	3.267 3.235	3.3 3.3	3.333 3.365	V
	1117-5.0, $I_{OUT} = 10mA$, $V_{IN} = 7.0V$ $10mA \leq I_{OUT} \leq 1A$, $6.5V \leq V_{IN} \leq 12V$	4.950 4.900	5.0 5.0	5.050 5.100	V
Line Regulation	1117-ADJ $I_{OUT} = 10mA$, $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		0.035	0.2	%
	1117-1.5 $I_{OUT} = 10mA$, $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	6	mV
	1117-1.8 $I_{OUT} = 10mA$, $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	6	mV
	1117-2.5 $I_{OUT} = 10mA$, $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	6	mV
	1117-3.3 $I_{OUT} = 10mA$, $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	6	mV
	1117-5.0 $I_{OUT} = 10mA$, $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	10	mV
Load Regulation	1117-ADJ $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$		0.2	0.4	%
	1117-1.5 $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$		1	10	mV
	1117-1.8 $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$		1	10	mV
	1117-2.5 $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$		1	10	mV
	1117-3.3 $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$		1	10	mV
	1117-5.0 $V_{IN} - V_{OUT} = 2V$, $10mA \leq I_{OUT} \leq 1A$		1	15	mV

Operating Conditions: $V_{IN} \leq 10V$, $T_J = 25^\circ C$ unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Unit
Dropout Voltage	$\Delta V_{REF} = 1\%$, $I_{OUT} = 0.1A$		1.00	1.1	V
	$\Delta V_{REF} = 1\%$, $I_{OUT} = 0.5A$		1.08	1.18	V
	$\Delta V_{REF} = 1\%$, $I_{OUT} = 1.0A$		1.15	1.25	V
Current Limit	$V_{IN} - V_{OUT} = 2V$	1.25	1.35		A
Adjust Pin Current			60	120	μA
Adjust Pin Current Change	$1.4V \leq V_{IN} - V_{OUT} \leq 10V$, $10mA \leq I_{OUT} \leq 1A$		0.2	5	μA
Minimum Load Current (ADJ)	$1.5V \leq V_{IN} - V_{OUT} \leq 10V$ (ADJ only)		1.7	5	mA
Quiescent Current	$V_{IN} = V_{OUT} + 1.25V$		5	10	mA
Ripple Rejection	$f = 120Hz$, $C_{OUT} = 22\mu F$ Tantalum, $V_{IN} - V_{OUT} = 3V$, $I_{OUT} = 1A$	60	75		dB
Temperature Stability			0.5		%
Long-Term Stability	$T_A = 125^\circ C$, 1000hrs		0.3		%
RMS Output Noise (% of V_{OUT})	$T_A = 25^\circ C$, $10Hz \leq f \leq 10KHz$		0.003		%
Thermal Resistance, Junction to Case *	SOT-89 SOT-223 TO-252/251 TO-220 TO-263		25 15 10 4.5 4		$^\circ C/W$
Thermal Shutdown	Junction Temperature		150		$^\circ C$
Thermal Shutdown Hysteresis			25		$^\circ C$

* With package soldering to copper area over backside ground plane or internal power plane $R_{\theta JA}$ can vary from $46^\circ C/W$ to $>90^\circ C/W$ depending on mounting technique and the size of the copper area.

Typical Applications

